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APPLICANTS

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\*\* CONTINUING DATA \*\*\*\*\*

✓ This application is a CON of 09/649,225 08/28/2000 PAT 6,599,822 which is a CON of 09/164,113 09/30/1998 PAT 6,214,716 *WAA*

\*\* FOREIGN APPLICATIONS \*\*\*\*\*

IF REQUIRED, FOREIGN FILING LICENSE GRANTED  
 \*\* 09/09/2003

Foreign Priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no	STATE OR COUNTRY ID	SHEETS DRAWING 11	TOTAL CLAIMS 8	INDEPENDENT CLAIMS 1
35 USC 119 (a-d) conditions met <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance				
Verified and Acknowledged Examiner's Signature: <i>[Signature]</i> Initials: <i>WAA</i>				

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TITLE  
 Methods of fabricating semiconductor substrate-based BGA interconnection

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